#### TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

# 2SK3075

#### RF POWER MOSFET FOR VHF-AND UHF-BAND POWER AMPLIFIER

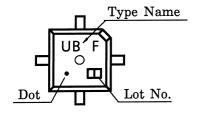
Output Power  $: P_{O} ≥ 7.5W$ Power Gain : GP > 11.7dBDrain Efficiency  $: nD \ge 50\%$ 

### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	$V_{DSS}$	30	V
Gate-Source Voltage	V <sub>GSS</sub>	25	V
Drain Current	I <sub>D</sub>	5	Α
Drain Power Dissipation	P <sub>D*</sub>	20	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature Range	T <sub>stg</sub>	-45~150	°C

<sup>\*:</sup> Tc = 25°C When mounted on a 1.6mm glass epoxy PCB

#### MARKING



Unit: mm
61.2±0.2 0.6±0.2 0.70
1. GATE
2. SOURCE (HEAT SINK) 3. DRAIN
JEDEC —
EIAJ —
TOSHIBA 2-5N1A

000707EAA1

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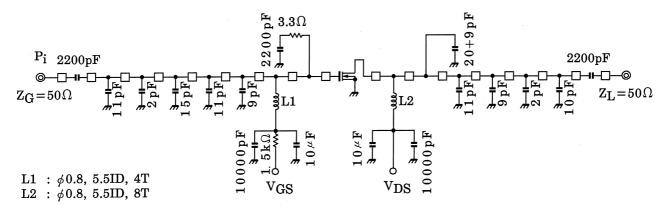
# **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

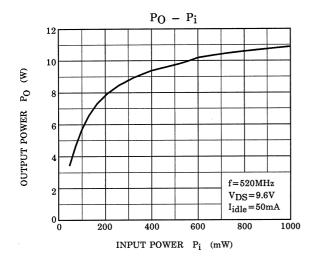
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Power	PO	$V_{DS} = 9.6V$ lidle = 50mA ( $V_{GS}$ = adjust) f = 520MHz, $P_i$ = 500mW $Z_G = Z_L = 50\Omega$	7.5	_	_	W
Drain Efficiency	$\eta_{D}$		50	_	_	%
Power Gain	G <sub>P</sub>		11.7	_	_	dB
Gate Threshold Voltage	$V_{th}$	V <sub>DS</sub> = 9.6V, I <sub>D</sub> = 0.5mA	1.0	1.5	2.0	V
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0	_	_	10	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0	_	_	5	μΑ

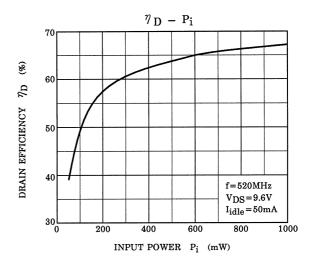
## HANDLING PRECAUTION

• When handling individual devices, be sure that working desks, human bodies and soldering iron are protected against electrostatic electricity.

#### RF OUTPUT POWER TEST FIXTURE







# **CAUTION**

These are only typical curves and devices are not necessarily guaranteed at these curves.